

Product Change Notice



PCN: PCN_SEDC3000ME_C2
Date: 05/1/2026

Kingston Technology Company, Inc.
17600 Newhope Street
Fountain Valley, CA 92708
USA

Type of Change: DRAM Component Change/Addition

Reason for Change: To ensure long-term supply continuity for DC3000ME, Kingston Technology is adding a second-source DRAM component to the (BOM) Bill of Materials. This addition is a proactive measure to mitigate supply chain risks throughout the product's lifecycle. The new component is a drop-in replacement that requires no firmware updates and results in no changes to the product's form, fit, or function.

Description of Change(s):

1. Adding a second source DRAM component (Micron) to the bill of material (BOM) for DC3000ME.
 2. No change to firmware. No change to form, fit or function of the DC3000ME.
 3. This component addition will create a second BOM revision which appears on the SSD label. Please make note of this if strict BOM control is required.
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Product(s) Affected:

- SEDC3000ME/3T8
 - SEDC3000ME/7T6
 - SEDC3000ME/15T3
 - SEDC3000ME/3T8BK
 - SEDC3000ME/7T6BK
 - SEDC3000ME/15T3BK
 - SEDC3000ME/30T7
 - SEDC3000ME/30T7BK
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Transition/Replacement Product:

- No change to model name, number or sku.
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Target Implementation:

June 2026

Contact Information:

Contact your Kingston sales representative for more information: <https://www.kingston.com/company/contacts>
